





MXB0761A - Preliminary 6.725-8.50 GHz Bandpass Filter

Features

- Low Loss with High Rejection
- Low ripple

Applications

- Receive band for Ku-Band Satcom
- Specialty wireless applications



Part Dimensions: 11.7 × 3.5? × 3.7 mm • 0.40? g

Materials: Ag plated ceramic block with fused-tin plated brass shield

Description

Surface mount ceramic bandpass filter. Superior rejection, insertion loss, reliability, as well as both peak and average power handling compared other bandpass filter technologies.

Electrical Specifications – specs are estimates based on simulation & subject to protoype verfication

Parameter	Frequency (GHz)	Typical at 25°C	Spec. at 25°C	Spec. over -40°C to +85°C
Nominal Impedance	-	50 ohms	-	-
Average Input Power	-	-	-	8.0 Watt max TBC
Peak Input Power	-	-	-	8.0 Watt max TBC
Input-Output Response				
Passband Insertion Loss (single point)	6.725 - 8.50	0.7-0.9 dB	1.0 dB min est	1.2 dB min est
Passband Return Loss	6.725 - 8.50	12-13 dB	10-11 dB min est	10-11 dB min est
Attenuation:	1 - 6.125		30 dB min	30 dB min
	6.25		26-27 dB min	26-27 dB min
	9.50 - 10.50		20 dB min	20 dB min

Note: CTS tests each unit to the critical specifications above. Subsequent audits may deviate due to repeatability among different test systems which shall not exceed these allowances. Specification Allowance Insertion Loss 0.1 dB Return Loss 1.0 dB Attenuation 1.0 dB

TBC = "to be confirmed" by the customer testing of prototypes.

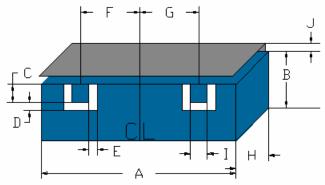
2023-02-07 Rev. A WWW.ctscorp.com Page 1 of 2

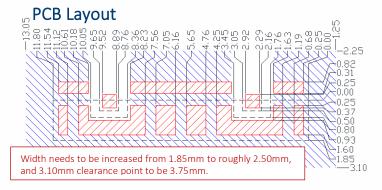


Preliminary - MXB0761A

6.725-8.50 GHz Bandpass Filter

Mechanical Drawing





Filter Solder Resist
Outline Over Dielectric

Exposed Solder Resist
Conductor Dver Conductor

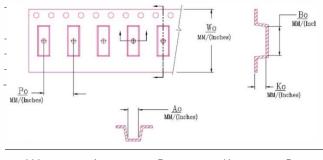
Nominal Tolerance Dim. (±mm or Max) (mm) Α 11.70 max В 2.50? max C 0.50 0.13 D 0.30 0.13 Е 0.40 0.13 F 3.30 0.13 G 3.30 0.13 Н 3.70 max 0.89 0.13 0.63 0.20

IMPORTANT: Please assure >=30mils (0.75mm) thickness of dielectric beneath the I/O Pads <u>and</u> the surrounding clearance zone down to the ground plane.

Please assure sufficient ground vias between the top metal ground plane and the primary ground plane.

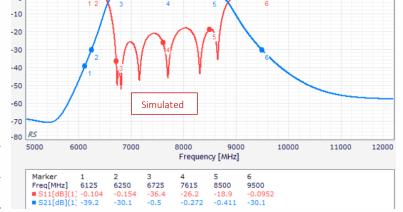
Recommended solder: 4-6 mils of SAC305 with reflow incl. 120s of soak at 217°C, and up to 30 sec peak at 241°C.

Packaging and Marking



W_{o}	A_{o}	Bo	Ko	Po
0.945 in	0.098 in	0.366 in	0.132 in	0.315 in
24.0 mm	??? mm	??? mm	??? mm	8.0 mm

Electrical Response



2023-02-07 Rev. A WWW.ctscorp.com Page 2 of 2